

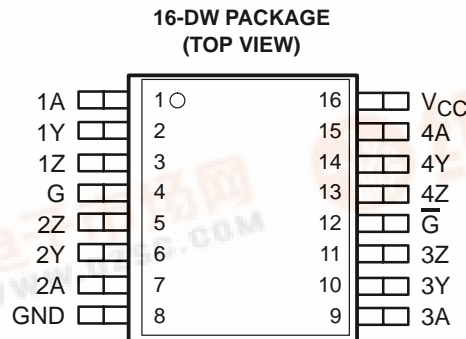
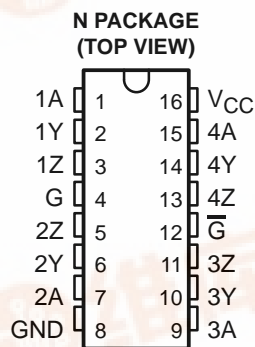
SN65LBC172A, SN75LBC172A QUADRUPLE RS-485 DIFFERENTIAL LINE DRIVERS

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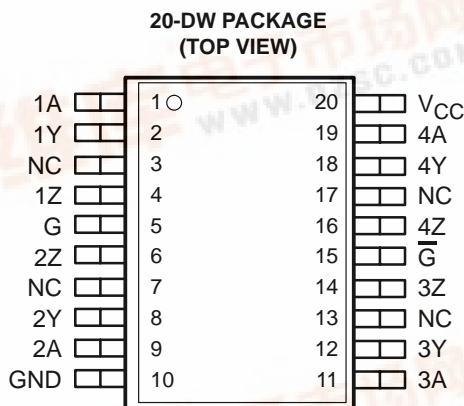
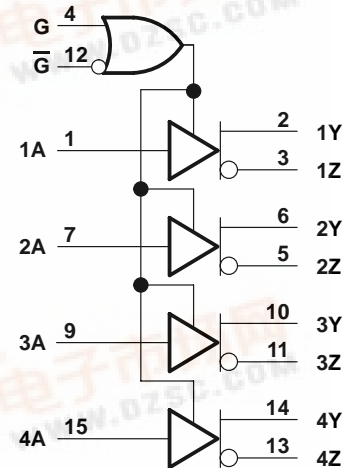
- Designed for TIA/EIA-485, TIA/EIA-422, and ISO 8482 Applications
- Signaling Rates† up to 30 Mbps
- Propagation Delay Times <11 ns
- Low Standby Power Consumption
1.5 mA Max
- Output ESD Protection Exceeds 13 kV
- Driver Positive- and Negative-Current Limiting
- Power-Up and Power-Down Glitch-Free for Live Insertion Applications
- Thermal Shutdown Protection
- Industry Standard Pin-Out, Compatible With SN75172, AM26LS31, DS96172, LTC486, and MAX3045

description

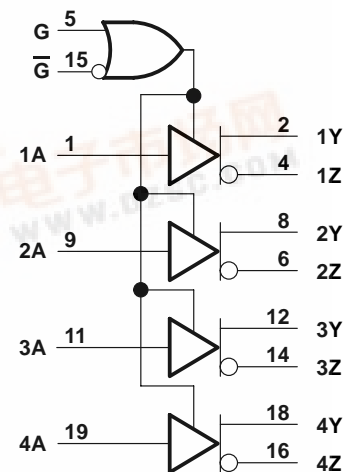
The SN65LBC172A and SN75LBC172A are quadruple differential line drivers with 3-state outputs, designed for TIA/EIA-485 (RS-485), TIA/EIA-422 (RS-422), and ISO 8482 applications.



logic diagram (positive logic)



logic diagram (positive logic)



LinBiCMOS is a trademark of Texas Instruments.

† The signaling rate of a line is the number of voltage transitions that are made per second expressed in the units bps (bits per second).

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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description (continued)

These devices are optimized for balanced multipoint bus transmission at signalling rates up to 30 million bits per second. The transmission media may be printed-circuit board traces, backplanes, or cables. The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media and the noise coupling to the environment.

Each driver features current limiting and thermal-shutdown circuitry making it suitable for high-speed multipoint data transmission applications in noisy environments. These devices are designed using LinBiCMOS™, facilitating low power consumption and robustness.

The G and \bar{G} inputs provide driver enable control using either positive or negative logic. When disabled or powered off, the driver outputs present a high-impedance to the bus for reduced system loading.

The SN75LBC172A is characterized for operation over the temperature range of 0°C to 70°C. The SN65LBC172A is characterized over the temperature range from -40°C to 85°C.

AVAILABLE OPTIONS

T _A	PACKAGE		
	16-PIN PLASTIC SMALL OUTLINE† (JEDEC MS-013)	20-PIN PLASTIC SMALL OUTLINE† (JEDEC MS-013)	16-PIN PLASTIC THROUGH-HOLE (JEDEC MS-001)
0°C to 70°C	SN75LBC172A16DW	SN75LBC172ADW	SN75LBC172AN
	Marked as 75LBC172A		
-40°C to 85°C	SN65LBC172A16DW	SN65LBC172ADW	SN65LBC172AN
	Marked as 65LBC172A		

† Add R suffix for taped and reeled version.

FUNCTION TABLE (EACH DRIVER)

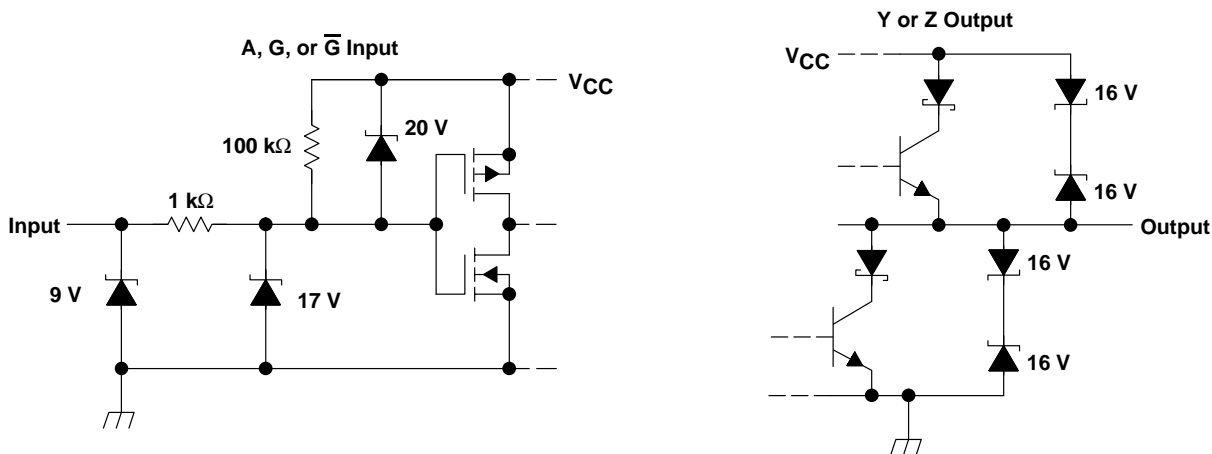
INPUT	ENABLES		OUTPUTS	
	G	\bar{G}	Y	Z
L	H	X	L	H
L	X	L	L	H
H	H	X	H	L
H	X	L	H	L
OPEN	H	X	H	L
OPEN	X	L	H	L
H	OPEN	X	H	L
L	OPEN	X	L	H
X	L	H	Z	Z
X	L	OPEN	Z	Z

H = high level, L = low level, X = irrelevant,
Z = high impedance (off)

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equivalent input and output schematic diagrams



absolute maximum ratings†

Supply voltage range, V_{CC} (see Note 1)	–0.3 V to 6 V
Output voltage range, V_O , at any bus (steady state)	–10 V to 15 V
Output voltage range, V_O , at any bus (transient pulse through 100 Ω , see Figure 8)	–30 V to 30 V
Input voltage range, V_I , at any A, G, or \bar{G} terminal	–0.5 V to $V_{CC} + 0.5$ V
Electrostatic discharge: Human body model (see Note 2)	Y, Z, and GND 13 kV
	All pins 5 kV
	Charged-device model (see Note 3) All pins 1 kV
Storage temperature range, T_{stg}	–65°C to 150°C
Continuous power dissipation	See Dissipation Rating Table
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential I/O bus voltages, are with respect to GND.
 2. Tested in accordance with JEDEC standard 22, Test Method A114–A.
 3. Tested in accordance with JEDEC standard 22, Test Method C101.

DISSIPATION RATING TABLE

PACKAGE	JEDEC BOARD MODEL	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR‡ ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
16-PIN DW	Low K	1200 mW	9.6 mW/°C	769 mW	625 mW
	High K	2240 mW	17.9 mW/°C	1434 mW	1165 mW
20-PIN DW	Low K	1483 mW	11.86 mW/°C	949 mW	771 mW
	High K	2753 mW	22 mW/°C	1762 mW	1432 mW
16-PIN N	Low K	1150 mW	9.2 mW/°C	736 mW	598 mW

‡ This is the inverse of the junction-to-ambient thermal resistance when board-mounted with no air flow.

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recommended operating conditions

		MIN	NOM	MAX	UNIT	
Supply voltage, V_{CC}		4.75	5	5.25	V	
Voltage at any bus terminal		Y, Z		-7	12	V
High-level input voltage, V_{IH}	A, G, \bar{G}	2		V_{CC}	V	
Low-level input voltage, V_{IL}		0		0.8		
Output current		-60	60		mA	
Operating free-air temperature, T_A	SN75LBC172A	0		70	°C	
	SN65LBC172A	-40		85		

electrical characteristics over recommended operating conditions

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IK}	Input clamp voltage	$I_I = -18$ mA		-1.5	-0.77		V
V_O	Open-circuit output voltage	Y or Z, No load		0		V_{CC}	V
$ V_{OD(SS)} $	Steady-state differential output voltage magnitude‡	No load (open circuit)		3		V_{CC}	V
		$R_L = 54 \Omega$, see Figure 1		1	1.6	2.5	
		With common-mode loading, see Figure 2		1	1.6	2.5	
$\Delta V_{OD(SS)}$	Change in steady-state differential output voltage between logic states	See Figure 1		-0.1		0.1	V
$V_{OC(SS)}$	Steady-state common-mode output voltage	See Figure 3		2	2.4	2.8	V
$\Delta V_{OC(SS)}$	Change in steady-state common-mode output voltage between logic states	See Figure 3		-0.02		0.02	V
I_I	Input current	A, G, \bar{G}		-50		50	μ A
I_{OS}	Short-circuit output current	$V_{TEST} = -7$ V to 12 V, See Figure 7	$V_I = 0$ V	-200		200	mA
I_{OZ}	High-impedance-state output current		$V_I = V_{CC}$	-50		50	
$I_{O(OFF)}$	Output current with power off		G at 0 V, \bar{G} at V_{CC}	-10		10	μ A
I_{CC}	Supply current	$V_I = 0$ V or V_{CC} , No load	All drivers enabled			23	mA
			All drivers disabled			1.5	

† All typical values are at $V_{CC} = 5$ V and 25°C.

‡ The minimum V_{OD} may not fully comply with TIA/EIA-485-A at operating temperatures below 0°C. System designers should take the possibility of lower output signal into account in determining the maximum signal transmission distance.

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switching characteristics over recommended operating conditions

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low-to-high level output	R _L = 54 Ω, C _L = 50 pF, see Figure 4	5.5	8	11	ns
t _{PHL}	Propagation delay time, high-to-low level output		5.5	8	11	ns
t _r	Differential output voltage rise time		3	7.5	11	ns
t _f	Differential output voltage fall time		3	7.5	11	ns
t _{sk(p)}	Pulse skew t _{PLH} – t _{PHL}		0.6		2	ns
t _{sk(o)}	Output skew†				2	ns
t _{sk(pp)}	Part-to-part skew‡				3	ns
t _{PZH}	Propagation delay time, high-impedance-to-high-level output	See Figure 5			25	ns
t _{PHZ}	Propagation delay time, high-level-output-to-high impedance				25	ns
t _{PZL}	Propagation delay time, high-impedance-to-low-level output	See Figure 6			30	ns
t _{PLZ}	Propagation delay time, low-level-output-to-high impedance				20	ns

† Output skew (t_{sk(o)}) is the magnitude of the time delay difference between the outputs of a single device with all of the inputs connected together.

‡ Part-to-part skew (t_{sk(pp)}) is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same input signals, the same supply voltages, at the same temperature, and have identical packages and test circuits.

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PARAMETER MEASUREMENT INFORMATION

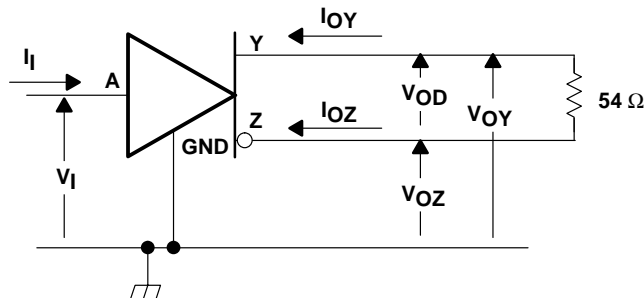


Figure 1. Test Circuit, V_{OD} Without Common-Mode Loading

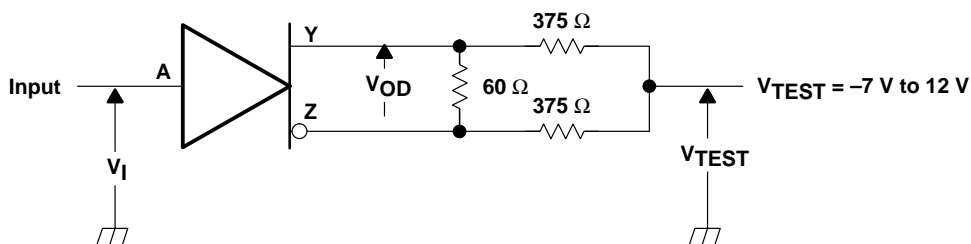
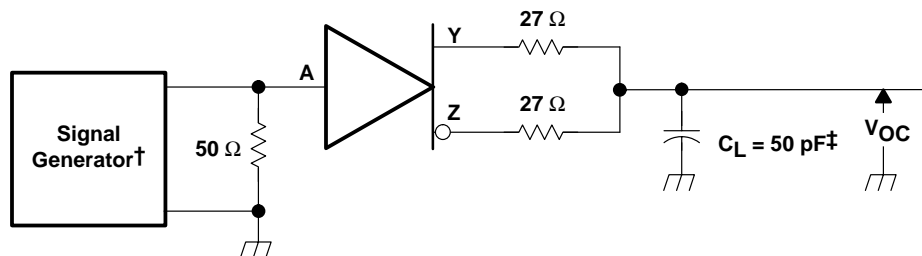


Figure 2. Test Circuit, V_{OD} With Common-Mode Loading



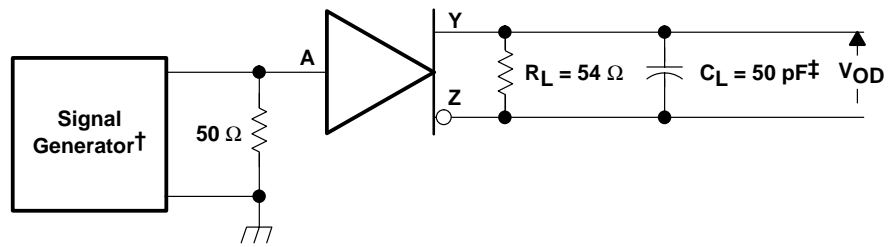
† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

Figure 3. V_{OC} Test Circuit

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† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

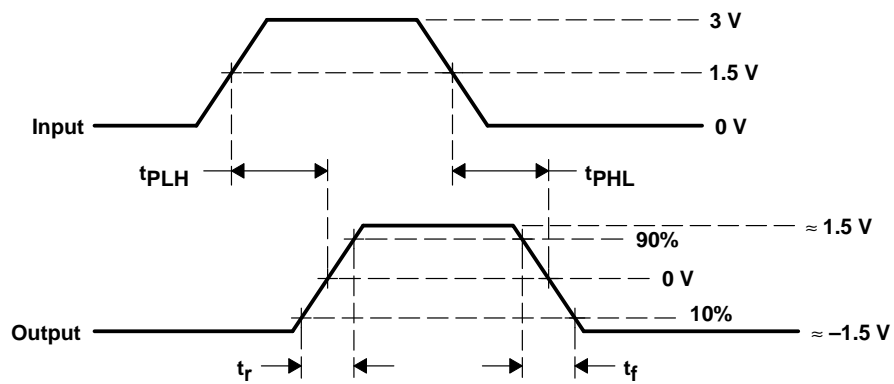
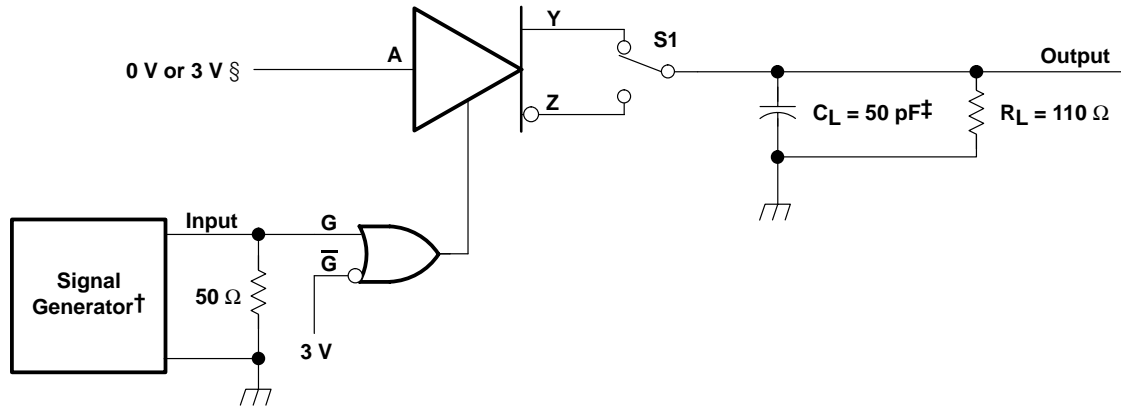


Figure 4. Output Switching Test Circuit and Waveforms

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PARAMETER MEASUREMENT INFORMATION



† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

§ 3-V if testing Y output, 0 V if testing Z output

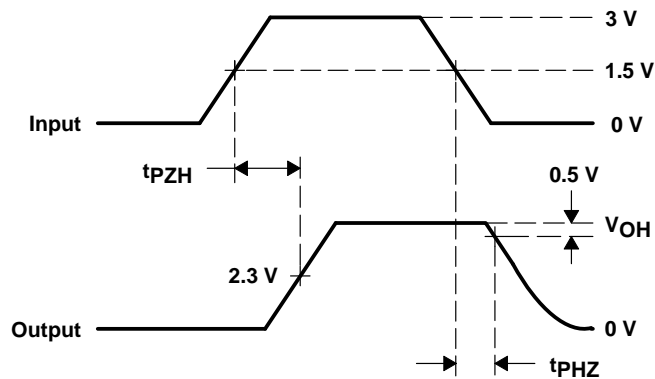
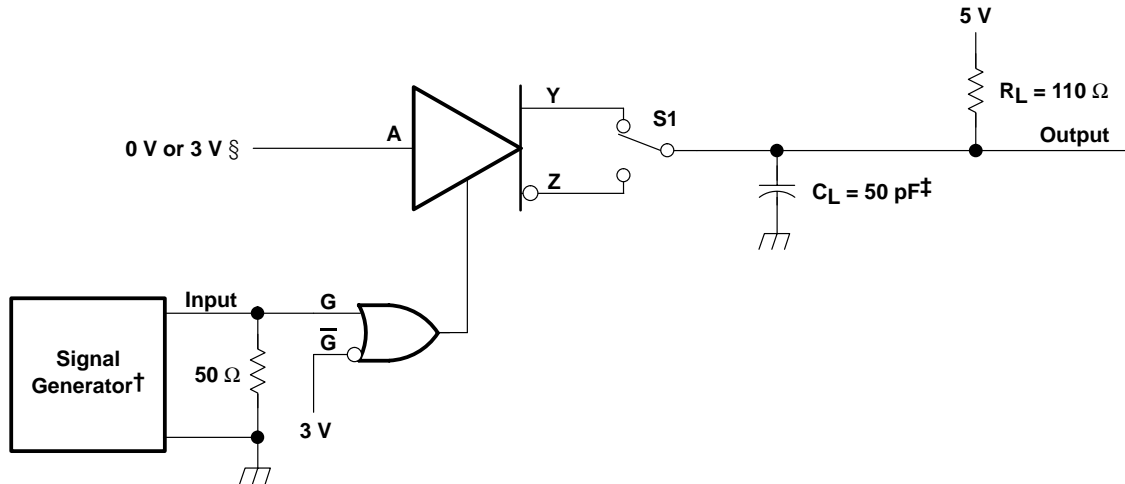


Figure 5. Enable Timing Test Circuit and Waveforms, t_{pZH} and t_{pHZ}

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PARAMETER MEASUREMENT INFORMATION



† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

§ 3-V if testing Y output, 0 V if testing Z output

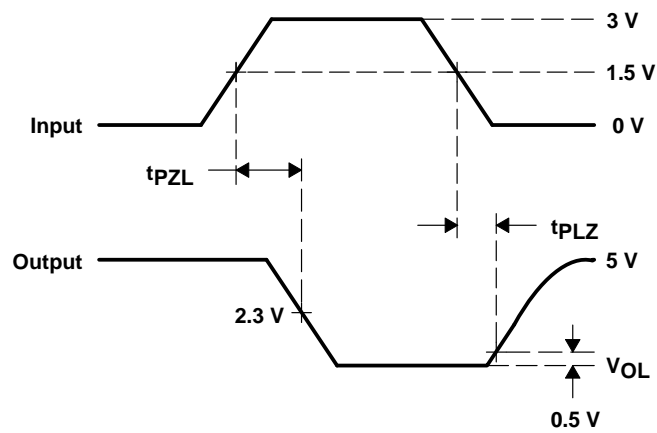


Figure 6. Enable Timing Test Circuit and Waveforms, t_{PZL} and t_{PLZ}

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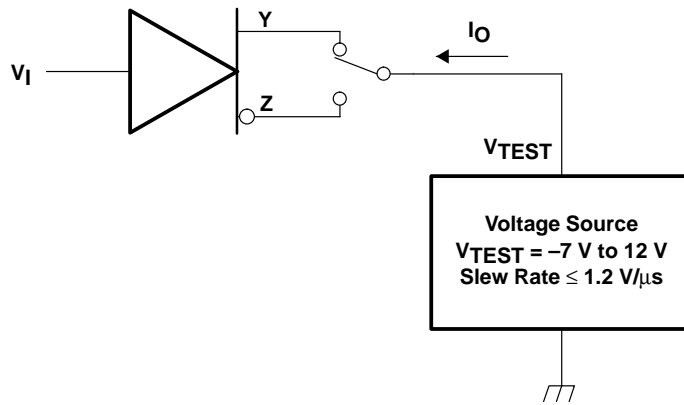


Figure 7. Test Circuit, Short-Circuit Output Current

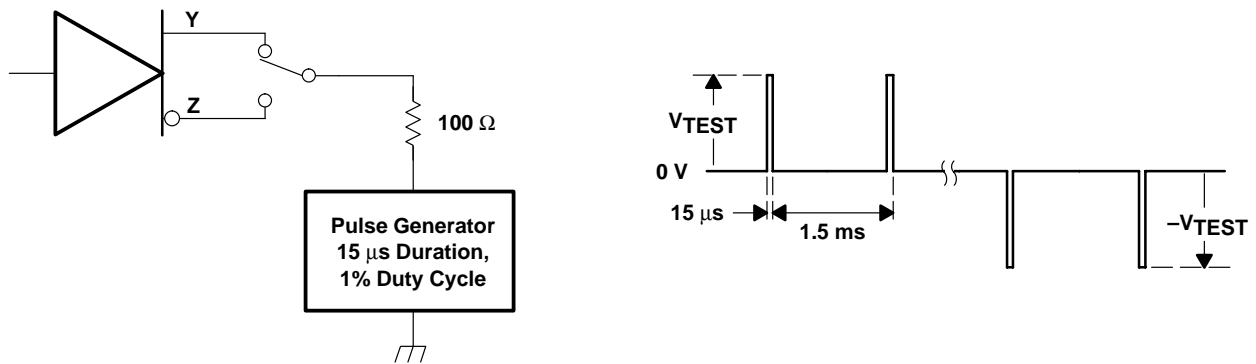


Figure 8. Test Circuit and Waveform, Transient Over-Voltage

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TYPICAL CHARACTERISTICS

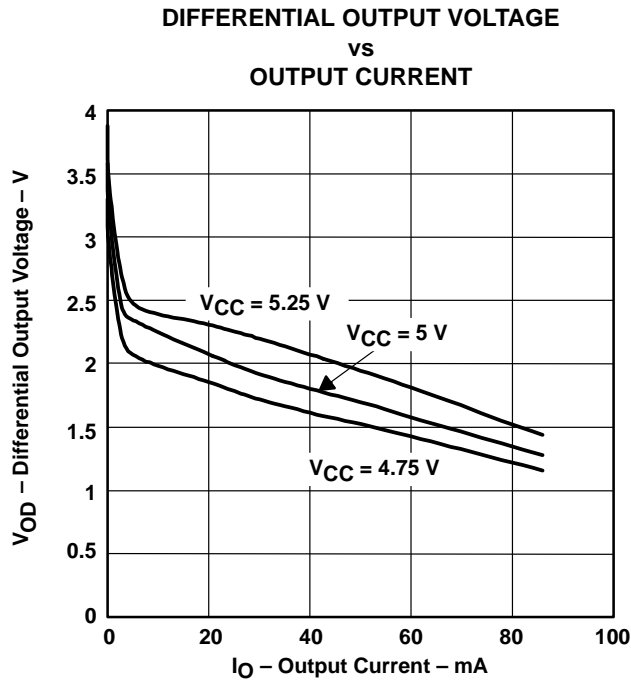


Figure 9

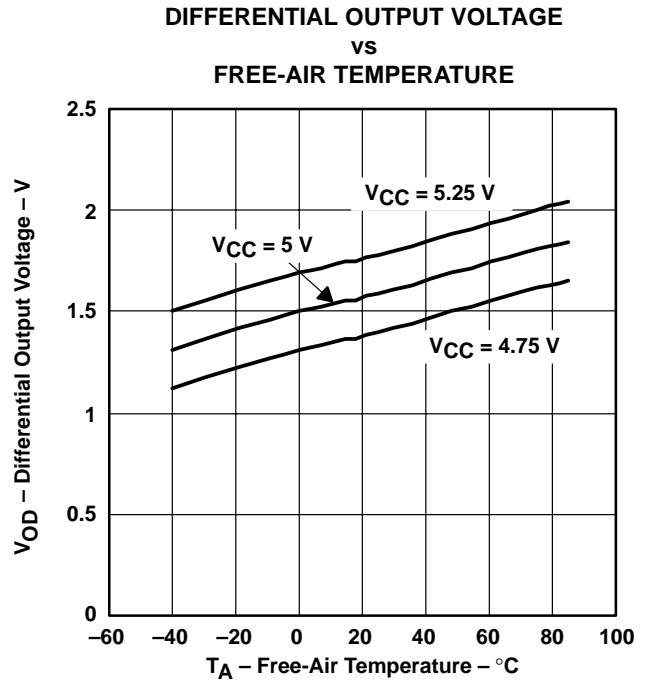


Figure 10

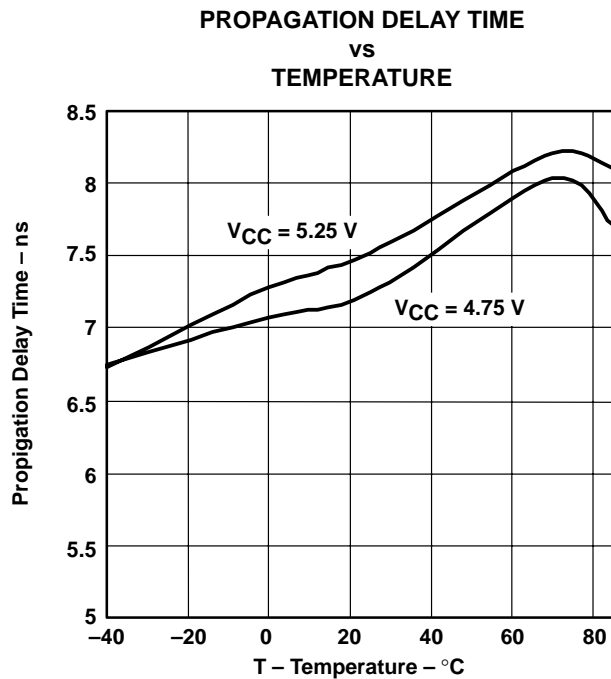


Figure 11

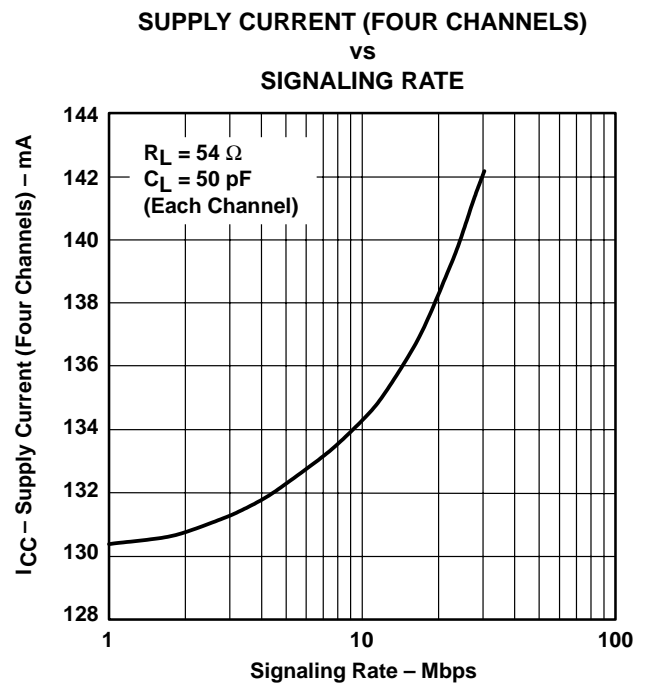


Figure 12

SN65LBC172A, SN75LBC172A QUADRUPLE RS-485 DIFFERENTIAL LINE DRIVERS

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TYPICAL CHARACTERISTICS

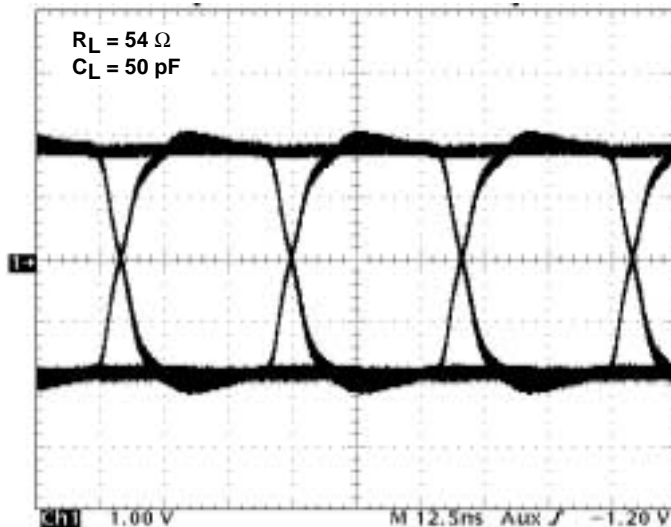


Figure 13. Eye Pattern, Pseudorandom Data at 30 Mbps

APPLICATION INFORMATION

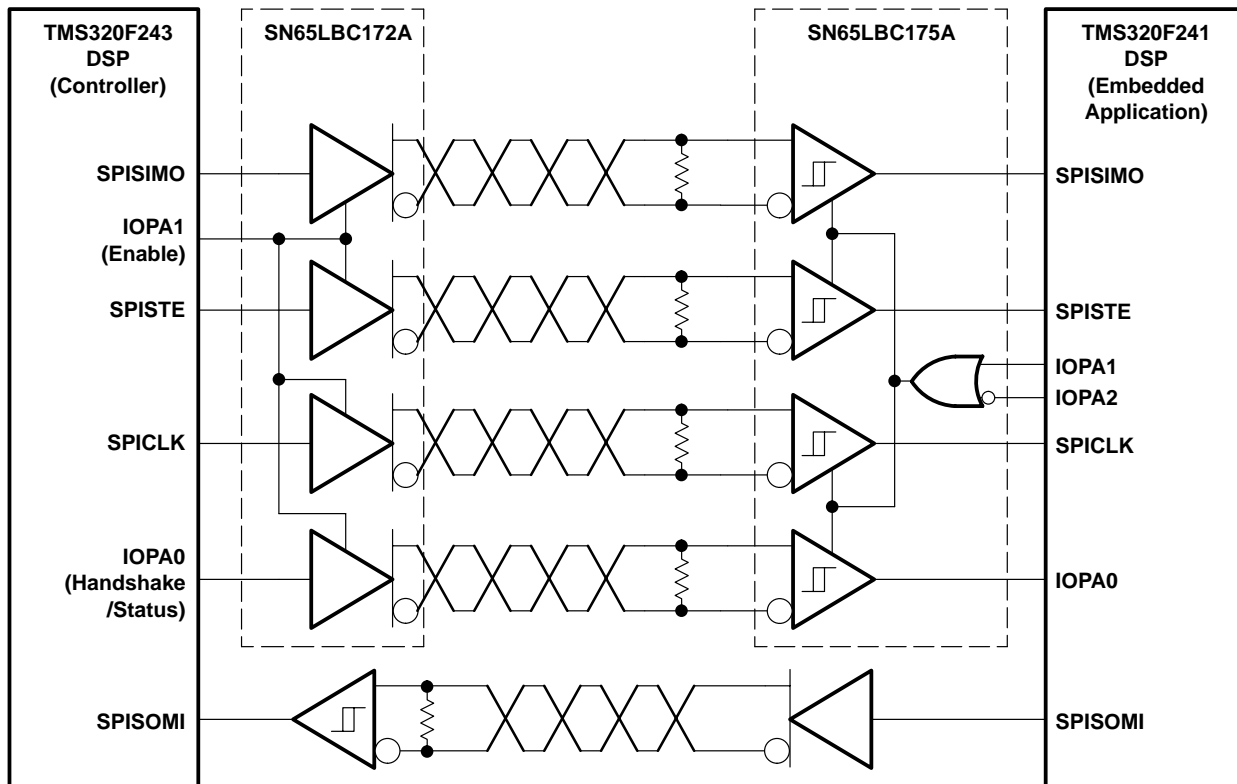


Figure 14. Typical Application Circuit, DSP-to-DSP Link via Serial Peripheral Interface

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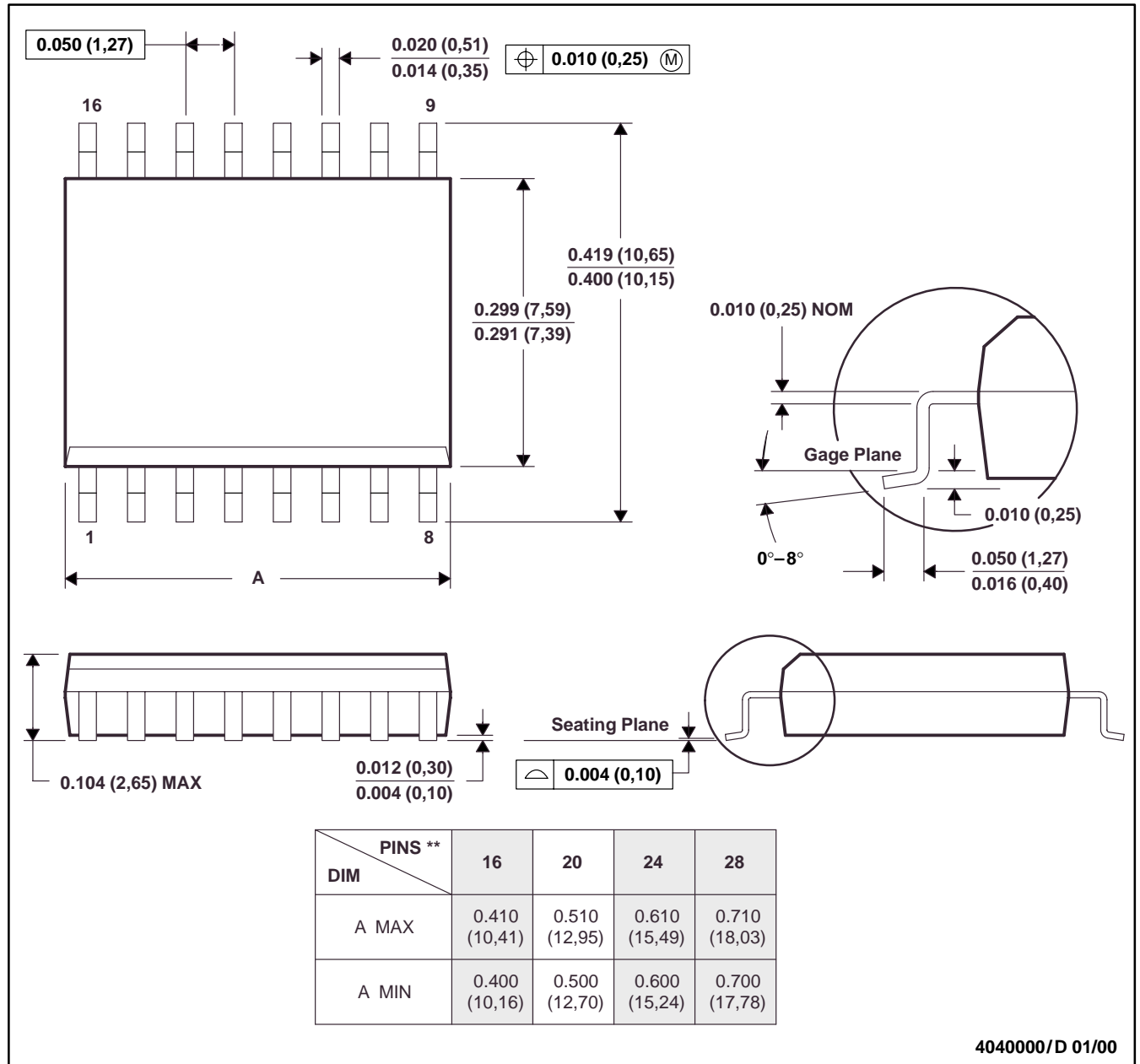
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MECHANICAL DATA

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

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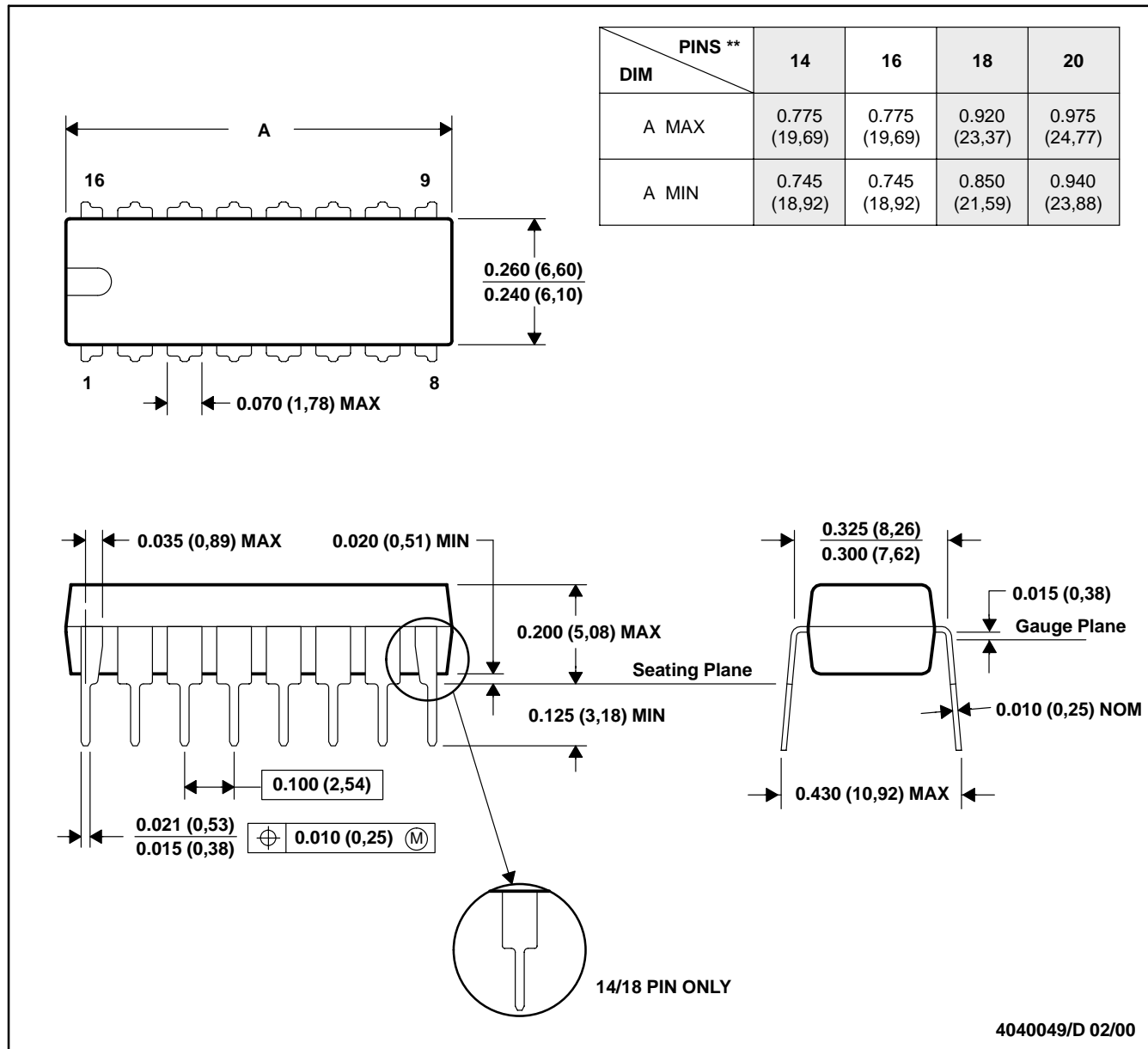
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MECHANICAL DATA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).

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